



# TinyLogic HS Unbuffered Inverter

### **NC7SU04**

#### **Description**

The NC7SU04 is a single special purpose CMOS Inverter. The inverter circuit is designed with a single unbuffered stage to facilitate use in crystal oscillator applications. It is not intended for use in logic inversion applications.

Advanced Silicon Gate CMOS fabrication assures high speed and low power circuit operation over a broad  $V_{CC}$  range. ESD protection diodes inherently guard both input and output with respect to the  $V_{CC}$  and GND rails.

#### **Features**

- Space Saving SOT23-5, SC-74A and SC-88A 5-Lead Package
- Ultra Small MicroPak<sup>™</sup> Leadless Package
- Unbuffered for Crystal Oscillator Applications
- Low Quiescent Power: I<sub>CC</sub> < 1 μA
- Balanced Output Drive: 2 mA I<sub>OL</sub>, -2 mA I<sub>OH</sub>
- Broad V<sub>CC</sub> Operating Range: 2 V 6 V
- Balanced Propagation Delays
- Specified for 3 V Operation
- These Devices are Pb–Free, Halogen Free/BFR Free and are RoHS Compliant

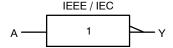
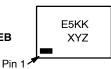


Figure 1. Logic Symbol

#### MARKING DIAGRAMS



SIP6 CASE 127EB





SC-74A CASE 318BQ





SOT23-5 CASE 527AH





SC-88A CASE 419A-02



E5, 7SU4, SU4 = Specific Device Code

KK = 2-Digit Lot Run Traceability Code XY = 2-Digit Date Code Format

Z = Assembly Plant Code

M = Data Code\* ■ Pb-Free Package

(Note: Microdot may be in either location)

 Date Code orientation and/or position may vary depending upon manufacturing location.

#### **ORDERING INFORMATION**

See detailed ordering, marking and shipping information in the package dimensions section on page 5 of this data sheet.

NOTE: Some of the devices on this data sheet have been **DISCONTINUED**. Please refer to the table on page 5.

#### **Pin Configurations**

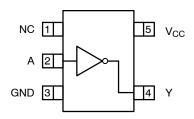


Figure 2. SOT23-5, SC-88A and SC-74A (Top View)

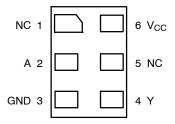


Figure 3. MicroPak (Top Through View)

#### **PIN DESCRIPTIONS**

Pin Name	Description
А	Input
Y	Output
NC	No Connect

#### **FUNCTION TABLE** $(Y = \overline{A})$

Inputs	Output
Α	Y
L	Н
Н	L

H = HIGH Logic Level L = LOW Logic Level

#### **ABSOLUTE MAXIMUM RATINGS**

Symbol	Param	Parameter		Max	Unit
V <sub>CC</sub>	Supply Voltage		-0.5	6.5	V
I <sub>IK</sub>	DC Input Diode Current V <sub>IN</sub> < 0 V		-	-20	mA
		V <sub>IN</sub> > V <sub>CC</sub>	-	+20	
V <sub>IN</sub>	DC Input Voltage		-0.5	V <sub>CC</sub> + 0.5	V
l <sub>ok</sub>	DC Output Diode Current	V <sub>OUT</sub> < 0 V	-	-20	mA
		V <sub>OUT</sub> > V <sub>CC</sub>	-	+20	
V <sub>OUT</sub>	DC Output Voltage		-0.5	V <sub>CC</sub> + 0.5	V
l <sub>OUT</sub>	DC Output Source or Sink Current		-	±12.5	mA
I <sub>CC</sub> or I <sub>GND</sub>	DC V <sub>CC</sub> or Ground Current per Output Pin		-	±25	mA
T <sub>STG</sub>	Storage Temperature		-65	+150	°C
TJ	Junction Temperature		-	+150	°C
T <sub>L</sub>	Lead Temperature (Soldering, 10 Seconds)		-	+260	°C
$P_{D}$	Power Dissipation in Still Air	SC-74A / SOT23-5	-	390	mW
		SC-88A	-	332	
		MicroPak-6	-	812	7

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

#### **RECOMMENDED OPERATING CONDITIONS**

Symbol	Parameter	Conditions	Min	Max	Unit
V <sub>CC</sub>	Supply Voltage		2.0	6.0	V
V <sub>IN</sub>	Input Voltage		0	V <sub>CC</sub>	V
V <sub>OUT</sub>	Output Voltage		0	V <sub>CC</sub>	V
T <sub>A</sub>	Operating Temperature		-40	+85	°C
$\theta_{JA}$	Thermal Resistance	SC-74A / SOT23-5	-	320	°C/W
		SC-88A	-	377	1
		MicroPak-6	-	154	

Functional operation above the stresses listed in the Recommended Operating Ranges is not implied. Extended exposure to stresses beyond the Recommended Operating Ranges limits may affect device reliability.

1. Unused inputs must be held HIGH or LOW. They may not float.

#### DC ELECTICAL CHARACTERISTICS

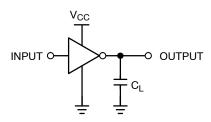
Symbo				-	T <sub>A</sub> = +25°C	;	T <sub>A</sub> = -40	to +85°C	
I	Parameter	V <sub>CC</sub> (V)	Conditions	Min	Тур	Max	Min	Max	Unit
V <sub>IH</sub>	HIGH Level Input Voltage	2.0 3.0 4.5 6.0		1.70 2.45 3.60 4.80	- - - -	- - - -	1.70 2.45 3.60 4.80	- - - -	V
V <sub>IL</sub>	LOW Level Input Voltage	2.0 3.0 4.5 6.0		- - - -	- - - -	0.30 0.50 0.90 1.20	- - - -	0.30 0.50 0.90 1.20	V
V <sub>OH</sub>	HIGH Level Output Voltage	2.0 3.0 4.5 6.0	$I_{OH} = -20 \mu A$ $V_{IN} = V_{IL}$	1.80 2.50 4.00 5.50	2.0 3.0 4.5 5.9	- - - -	1.80 2.50 4.00 5.50	- - - -	V
		3.0 4.5 6.0	$V_{IN} = GND$ $I_{OH} = -1.3 \text{ mA}$ $I_{OH} = -2.0 \text{ mA}$ $I_{OH} = -2.6 \text{ mA}$	2.68 4.18 5.68	2.82 4.33 5.76	- - -	2.63 4.13 5.63	- - -	V
V <sub>OL</sub>	LOW Level Output Voltage	2.0 3.0 4.5 6.0	$I_{OL} = 20 \mu A$ $V_{IN} = V_{IH}$	- - -	0.00 0.00 0.01 0.04	0.20 0.50 0.50 0.50	- - -	0.20 0.50 0.50 0.50	V
		3.0 4.5 6.0	$\begin{aligned} &V_{IN} = V_{CC} \\ &I_{OL} = 1.3 \text{ mA} \\ &I_{OL} = 2.0 \text{ mA} \\ &I_{OL} = 2.6 \text{ mA} \end{aligned}$	- - -	0.11 0.12 0.15	0.26 0.26 0.26	- - -	0.33 0.33 0.33	V
I <sub>IN</sub>	Input Leakage Current	6.0	V <sub>IN</sub> = V <sub>CC</sub> , GND	-	_	±0.1	-	±1.0	μΑ
I <sub>CC</sub>	Quiescent Supply Current	6.0	$V_{IN} = V_{CC}$ , GND	-	_	1.0	-	10.0	μΑ

#### **AC ELECTRICAL CHARACTERISTICS**

				7	Γ <sub>A</sub> = +25°C			-40 to 5°C	
Symbol	Parameter	V <sub>CC</sub> (V)	Conditions	Min	Тур	Max	Min	Max	Unit
t <sub>PLH</sub> ,	Propagation Delay (Figure 4, 6)	5.0	C <sub>L</sub> = 15 pF	_	3	15	_	_	ns
t <sub>PHL</sub>		2.0 3.0 4.5 6.0	C <sub>L</sub> = 50 pF	- - -	17 9 7 6.5	100 27 20 17	- - - -	125 35 25 21	ns
t <sub>TLH</sub> ,	Output Transition Time	5.0	C <sub>L</sub> = 15 pF	-	4	10	_	_	ns
<sup>†</sup> THL	(Figure 4, 6)	2.0 3.0 4.5 6.0	C <sub>L</sub> = 50 pF	- - - -	25 16 12 10	125 35 25 21	- - - -	155 45 31 26	ns
C <sub>IN</sub>	Input Capacitance	Open		_	2	10	_	10	pF
C <sub>PD</sub>	Power Dissipation Capacitance (Figure 5)	5.0	(Note 2)	İ	4	-	-	-	pF

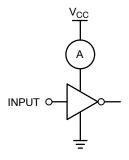
<sup>2.</sup> C<sub>PD</sub> is defined as the value of the internal equivalent capacitance which is derived from dynamic operating current consumption (I<sub>CCD</sub>) at no output loading and operating at 50% duty cycle. C<sub>PD</sub> is related to I<sub>CCD</sub> dynamic operating current by the expression: I<sub>CCD</sub> = (C<sub>PD</sub>) (V<sub>CC</sub>) (f<sub>IN</sub>) + (I<sub>CC</sub>static).

#### **AC Loading and Waveforms**



 $C_L$  includes load and stray capacitance Input PRR = 1.0 MHz;  $t_W$  = 500 ns

Figure 4. AC Test Circuit



Input = AC Waveform;

PRR = Variable; Duty Cycle = 50%.

Figure 5.  $I_{CCD}$  Test Circuit

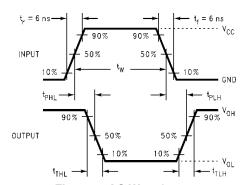


Figure 6. AC Waveforms

#### **ORDERING INFORMATION**

Order Number	Top Mark	Package Description	Shipping <sup>†</sup>
NC7SU04M5X	7SU4	SC-74A	3000 / Tape & Reel
NC7SU04P5X	SU4	SC-88A	3000 / Tape & Reel
NC7SU04L6X	E5	SIP6, MicroPak	5000 / Tape & Reel

#### **DISCONTINUED** (Note 3)

NC7SU04M5X-L22090	7SU4	SOT23-5	3000 / Tape & Reel
NC7SU04P5X-L22057	SU4	SC-88A	3000 / Tape & Reel
NC7SU04L6X-L22175	E5	SIP6, MicroPak	5000 / Tape & Reel

For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.

3. **DISCONTINUED:** These devices are not available. Please contact your **onsemi** representative for information. The most current information

on these devices may be available on www.onsemi.com.



**ISSUE O DATE 31 AUG 2016** 2X 0.05 C 1.45 В 2X (1) $\bigcirc$  0.05 C (0.49)(0.254)1.00 5X \ (0.75)(0.52)TOP VIEW Α 1X <u>1</u> PIN 1 IDENTIFIER /5\ 0.50±0.05 (0.30)6X PIN 1 0.05 RECOMMENED 0.00 LAND PATTERN 0.05 C - 0.35±0.05 С 1.45±0.05 -0.20±0.05 6X DETAIL A 1.0 0.10M|C|B|A

0.05(M)

0.30±0.05 5X

0.35±0.05 5X

(0.125)

4X

**SIP6 1.45X1.0** CASE 127EB

NOTES:

1.00±0.05

(0.050)

6X

1. CONFORMS TO JEDEC STANDARD MO-252 VARIATION UAAD

0.5

- 2. DIMENSIONS ARE IN MILLIMETERS
- 3. DRAWING CONFORMS TO ASME Y14.5M-2009

**BOTTOM VIEW** 

- 4.PIN ONE IDENTIFIER IS 2X LENGTH OF ANY
  - OTHER LINE IN THE MARK CODE LAYOUT.

DOCUMENT NUMBER:	P8AON13590G Electronic versions are uncontrolled except when accessed Printed versions are uncontrolled except when stamped "Co		
DESCRIPTION:	SIP6 1.45X1.0		PAGE 1 OF 1

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0.40±0.05

**PIN 1 TERMINAL** 

**DETAIL** A

0.075 X 45°

CHAMFER

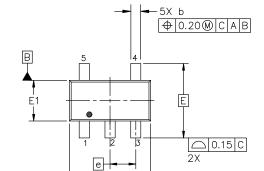


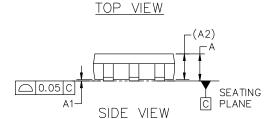
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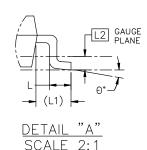


#### SC-74A-5 3.00x1.50x0.95, 0.95P CASE 318BQ ISSUE C

**DATE 26 FEB 2024** 







## GENERIC MARKING DIAGRAM\*



XXX = Specific Device Code

M = Date Code

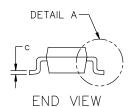
= Pb-Free Package

(Note: Microdot may be in either location)

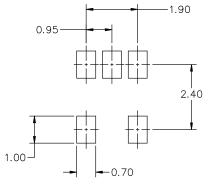
\*This information is generic. Please refer to device data sheet for actual part marking. Pb-Free indicator, "G" or microdot " •", may or may not be present. Some products may not follow the Generic Marking.

#### NOTES:

- DIMENSIONING AND TOLERANCING CONFORM TO ASME Y14.5-2018.
- 2. ALL DIMENSION ARE IN MILLIMETERS (ANGLES IN DEGREES).
- 3. MAXIMUM LEAD THICKNESS INCLUDES LEAD FINISH THICKNESS. MINIMUM LEAD THICKNESS IS THE MINIMUM THICKNESS OF BASE MATERIAL.
- 4. DIMENSIONS D AND E1 DO NOT INCLUDE MOLD FLASH, PROTRUSIONS OF GATE BURRS. MOLD FLASH, PROTRUSIONS, OR GATE BURRS SHALL NOT EXCEED 0.15 PER SIDE.



DIM	М	ILLIMETER	RS	
DIIVI	MIN.	NOM.	MAX.	
Α	0.90	1.00	1.10	
A1	0.01	0.18	0.10	
A2	(	0.95 REF		
b	0.25	0.37	0.50	
С	0.10	0.18	0.26	
D	2.85	3.00	3.15	
Е	:	2.75 BSC	;	
E1	1.35	1.50	1.65	
е	(	0.95 BSC	)	
L	0.20	0.40	0.60	
L1	0.62 REF.			
L2	0.25 BSC			
Θ	0,	5*	10°	



#### RECOMMENDED MOUNTING FOOTPRINT\*

\* FOR ADDITIONAL INFORMATION ON OUR Pb-FREE STRATEGY AND SOLDERING DETAILS, PLEASE DOWNLOAD THE ON SEMICONDUCTOR SOLDERING AND MOUNTING TECHNIQUES REFERENCE MANUAL, SOLDERRM/D.

DOCUMENT NUMBER:	98AON66279G	Electronic versions are uncontrolled except when accessed directly fron Printed versions are uncontrolled except when stamped "CONTROLLEI	
DESCRIPTION	SC-74A-5 3.00x1.50x0.95	0.95P	PAGE 1 OF 1

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#### SC-88A (SC-70-5/SOT-353) CASE 419A-02 ISSUE M

**DATE 11 APR 2023** 

#### NOTES:

- 1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.
- CONTROLLING DIMENSION: MILLIMETERS
- OR GATE BURRS SHALL NOT EXCEED 0.1016MM PER SIDE.

DIM	MILLIMETERS			
ואונת	MIN.	N□M.	MAX.	
А	0.80	0.95	1.10	
A1			0.10	
A3		0.20 REF	•	
b	0.10	0.20	0.30	
C	0.10		0.25	
D	1.80	2.00	2,20	
Е	2.00	2.10	2.20	
E1	1.15	1.25	1.35	
е	0,65 BSC			
L	0.10	0.15	0.30	

- 419A-01 DBSDLETE, NEW STANDARD 419A-02
- DIMENSIONS D AND E1 DO NOT INCLUDE MOLD FLASH, PROTRUSIONS, OR GATE BURRS. MOLD FLASH, PROTRUSIONS,

	L <del> </del> <del> </del>		
<u> </u>	0.50	5	

5X b

◆ 0.2 M B M

#### RECOMMENDED MOUNTING FOOTPRINT

For additional information on our Pb-Free strategy and soldering details, please download the DN Semiconductor Soldering and Mounting Techniques Reference Manual, SDLDERRM/D.

5. COLLECTOR

#### **GENERIC MARKING DIAGRAM\***



\*This information is generic. Please refer to device data sheet for actual part marking. Pb-Free indicator, "G" or microdot "■", may or may not be present. Some products may not follow the Generic Marking.

XXX = Specific Device Code

= Date Code

= Pb-Free Package

(Note: Microdot may be in either location)

STYLE 1: PIN 1. BASE 2. EMITTER 3. BASE 4. COLLECTOR 5. COLLECTOR	STYLE 2: PIN 1. ANODE 2. EMITTER 3. BASE 4. COLLECTOR 5. CATHODE	STYLE 3: PIN 1. ANODE 1 2. N/C 3. ANODE 2 4. CATHODE 2 5. CATHODE 1	STYLE 4: PIN 1. SOURCE 1 2. DRAIN 1/2 3. SOURCE 1 4. GATE 1 5. GATE 2	STYLE 5: PIN 1. CATHODE 2. COMMON ANODE 3. CATHODE 2 4. CATHODE 3 5. CATHODE 4
STYLE 6: PIN 1. EMITTER 2 2. BASE 2 3. EMITTER 1 4. COLLECTOR 5. COLLECTOR 2/BASE 1	STYLE 7: PIN 1. BASE 2. EMITTER 3. BASE 4. COLLECTOR 5. COLLECTOR	STYLE 8: PIN 1. CATHODE 2. COLLECTOR 3. N/C 4. BASE 5. EMITTER	STYLE 9: PIN 1. ANODE 2. CATHODE 3. ANODE 4. ANODE 5. ANODE	Note: Please refer to datasheet for style callout. If style type is not called out in the datasheet refer to the device datasheet pinout or pin assignment.

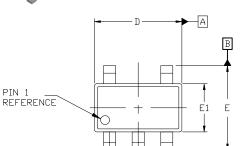
DOCUMENT NUMBER:	98ASB42984B	Electronic versions are uncontrolled except when accessed directly from the Document Repository Printed versions are uncontrolled except when stamped "CONTROLLED COPY" in red.		
DESCRIPTION:	SC-88A (SC-70-5/SOT-353)		PAGE 1 OF 1	

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5. COLLECTOR 2/BASE 1

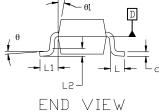






### 

TOP VIEW



### GENERIC MARKING DIAGRAM\*



XXX = Specific Device Code
M = Date Code

\*This information is generic. Please refer to device data sheet for actual part marking. Pb-Free indicator, "G" or microdot "•", may or may not be present. Some products may not follow the Generic Marking.

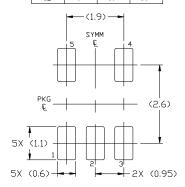
#### SOT-23, 5 Lead CASE 527AH ISSUE A

**DATE 09 JUN 2021** 

#### NOTES:

- 1. DIMENSIONING AND TOLERANCING PER ASME Y14.5M, 19894
- CONTROLLING DIMENSION: MILLIMETERS
- MAXIMUM LEAD THICKNESS INCLUDES LEAD FINISH THICKNESS.
   MINIMUM LEAD THICKNESS IS THE MINIMUM THICKNESS OF THE BASE MATERIAL.
- 4. DIMENSIONS D AND E1 DO NOT INCLUDE MOLD FLASH, PROTRUSIONS, OR GATE BURRS. MOLD FLASH, PROTRUSIONS, OR GATE BURRS SHALL NOT EXCEED O. 25 PER SIDE. D AND E1 DIMENSIONS ARE DETERMINED AT DATUM D.
- 5. DIMENSION '6' DOES NOT INCLUDE DAMBAR PROTRUSION. ALLOWABLE DAMBAR PROTRUSION SHALL BE 0.08mm TOTAL IN EXCESS OF THE '6' DIMENSION AT MAXIMUM MATERIAL CONDITION. MINIMUM SPACE BETWEEN PROTRUSION AND AN ADJACENT LEAD SHALL NOT BE LESS THAN 0.07mm.

	MILLIMETERS			
DIM	MIN.	N□M.	MAX.	
Α	0.90	_	1.45	
A1	0.00	_	0.15	
A2	0.90	1.15	1.30	
b	0.30	_	0.50	
C	0.08	_	0.22	
D	2.90 BSC			
Ε	2.80 BSC			
E1	1.60 BSC			
е	0.95 BSC			
L	0.30	0.45	0.60	
L1	0.60 REF			
L2	0.25 REF			
θ	0°	4°	8°	
θ1	0°	10°	15°	
θ2	0°	10°	15°	



### RECOMMENDED MOUNTING FOOTPRINT

For additional information on our Pb-Free strategy and soldering details, please download the DN Semiconductor Soldering and Mounting Techniques Reference Manual, SDL DERRM/D.

DOCUMENT NUMBER:	98AON34320E	Electronic versions are uncontrolled except when accessed directly from the Document Reposito Printed versions are uncontrolled except when stamped "CONTROLLED COPY" in red.		
DESCRIPTION:	SOT-23, 5 LEAD		PAGE 1 OF 1	

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